

Radon emanation suppression by surface coating

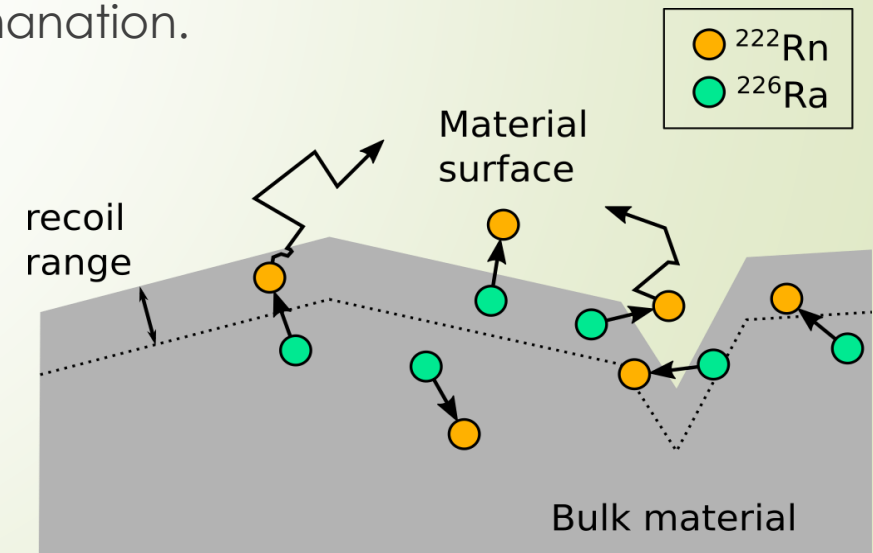
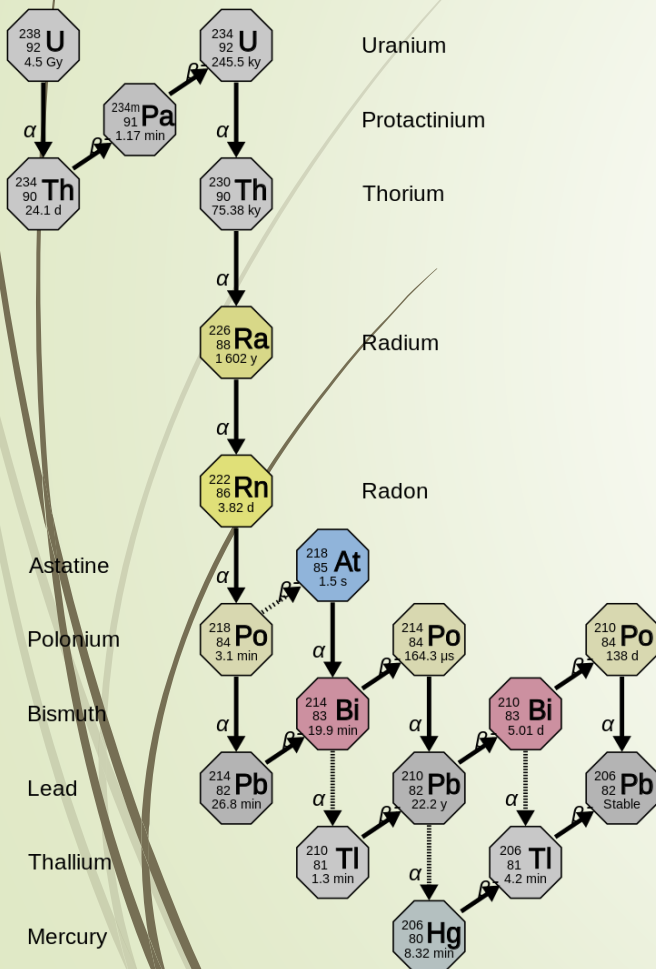
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Radon background in low energy astroparticle physics experiments

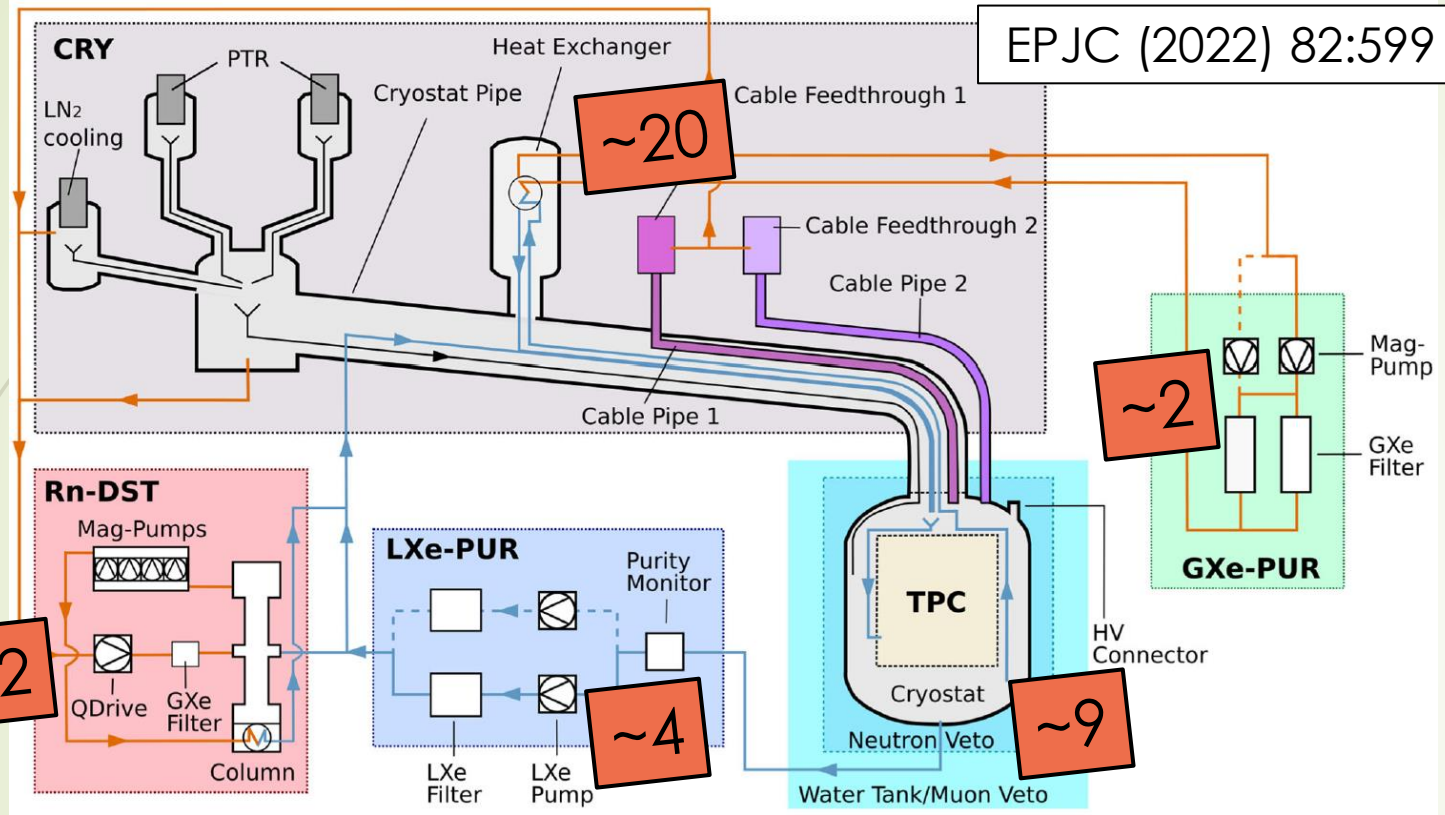
- Radon (in particular ^{222}Rn) is serious source of background in many astroparticle physics experiments.
- Noble gas: Diffusion!
- Followed by chain of radioactive isotopes.
- Not only radon in environment (atmosphere), but also radon sources in detector (part of natural uranium/thorium decay chains).
- Recoil- and diffusion-driven radon emanation.
- Radon mitigation requires
 - Radon removal
 - and
 - Radium removal (mother element).



Radon background in XENONnT

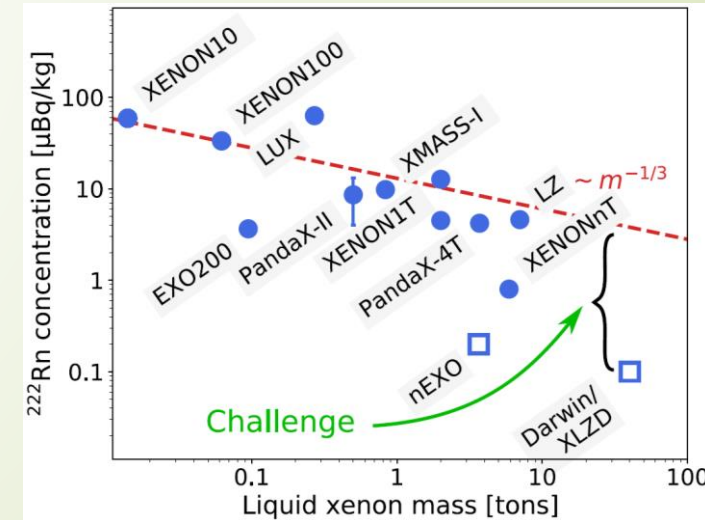
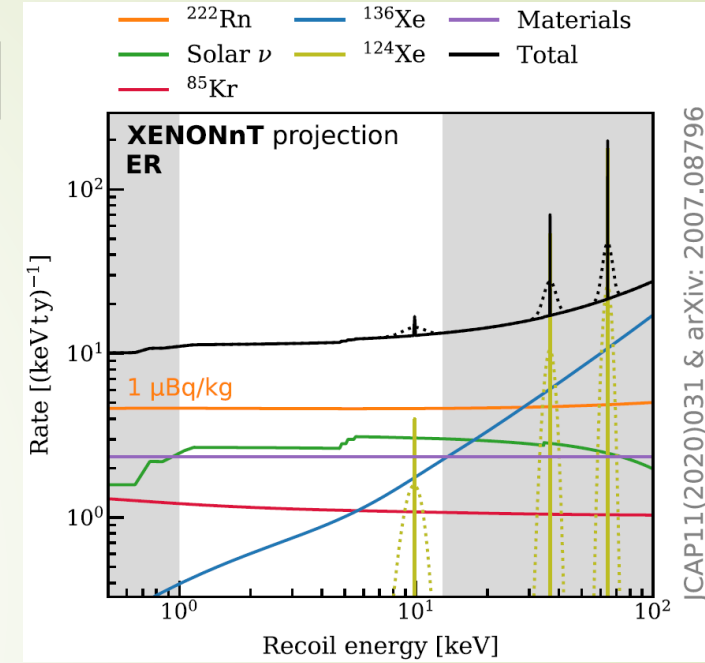
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All units [mBq]

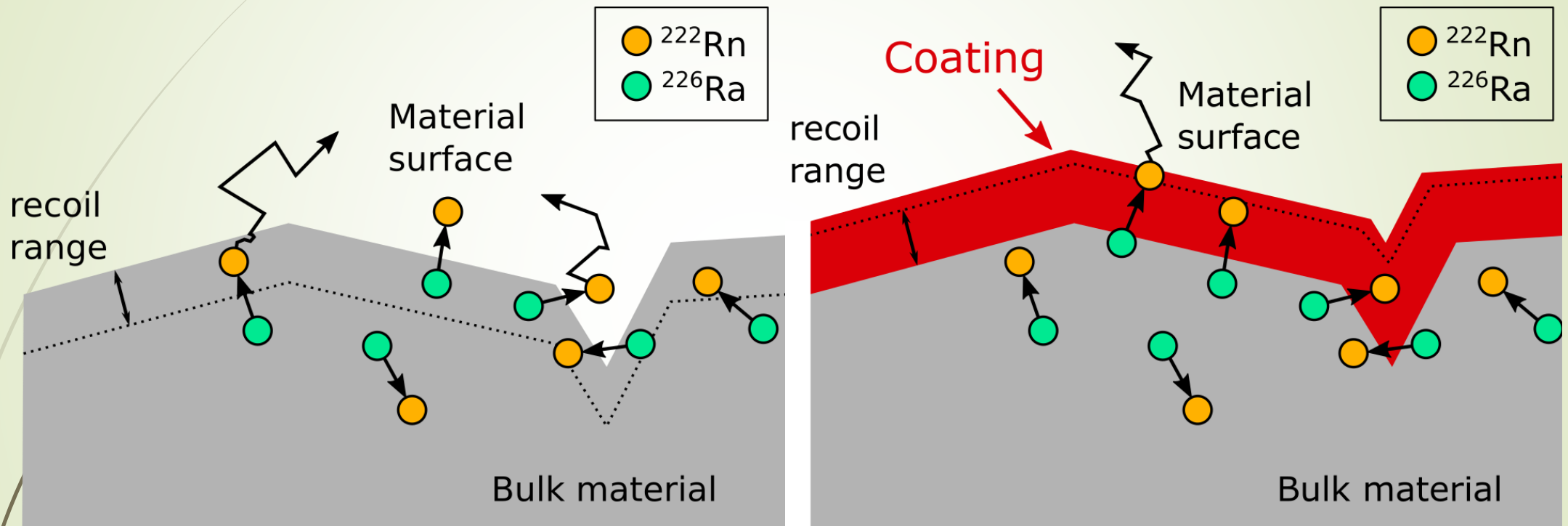


- ^{222}Rn is dominant background source in XENONnT.
- Various sources distributed over entire experimental infrastructure.
- $<1 \mu\text{Bq/kg}$ achieved (material selection and cleaning, online Xe distillation).
- Future experiments require even stronger radon suppression.

➔ Novel radon mitigation techniques!



Radon mitigation by surface coating



- Idea: A Rn-tight, clean (Ra-free) surface coating blocks Rn-emanation.
- Should work for recoil-driven (86 keV) AND diffusion-driven emanation.

Rn reduction factors for thoriated welding rods

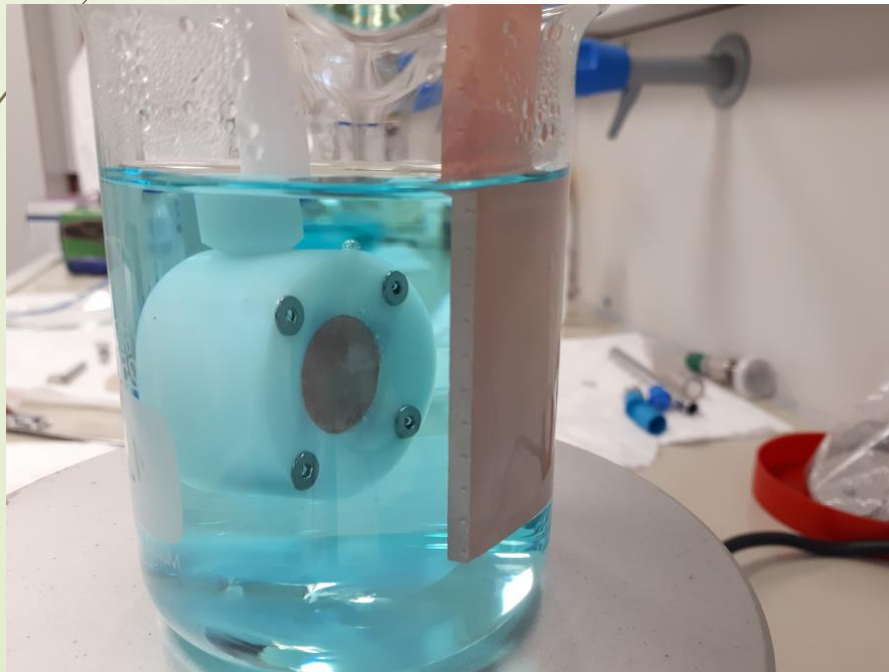


Method	Coated material	Company	^{220}Rn reduction	^{222}Rn reduction
Physical vapor deposition (sputtering)	Ti	Europcoating	1 – 5	~1
Chemical vapor deposition	C-H	Innovative Coating Solutions	~3	~1,5
Plasma deposition	Cu	Dr. Laure	2 – 20	---

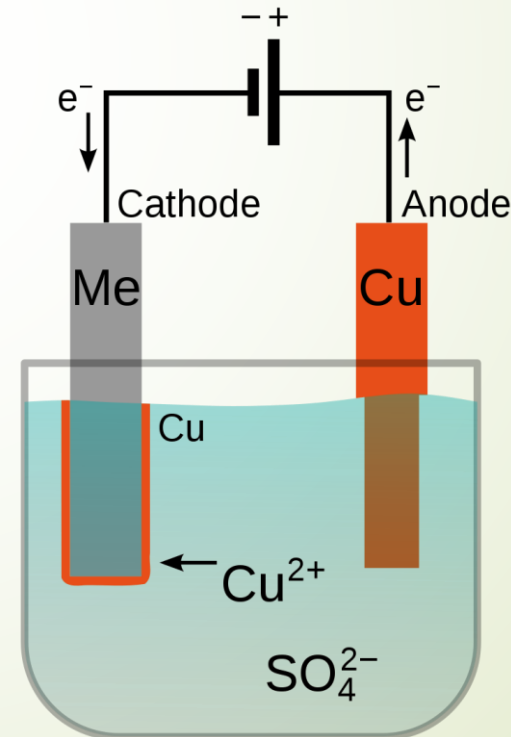
- Measurements with electrostatic detectors (^{220}Rn) and proportional counters (^{222}Rn).
- 4% thoriated welding rods: First simple metallic Rn-emanating sample.
- Little ^{220}Rn reduction and essentially no ^{222}Rn reduction observed.
- Best result for „hot“ plasma deposition, but re-evaporation due to hot substrate.

Copper electro-deposition

- Motivated by experience with electro-formed copper (clean!).
- In-house development at MPIK: $\sim 5 \mu\text{m}$ thick Cu layer.
- Good mechanical stability on tungsten.
- Efficient blocking of ^{224}Ra alpha-decay.
- ^{220}Rn reduction factor of ~ 100 for thoriated tungsten rods observed!

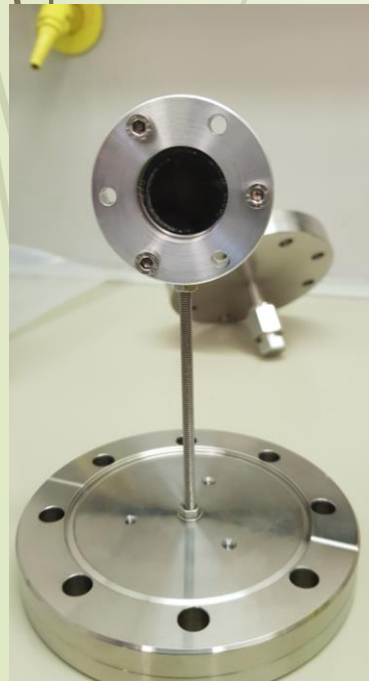
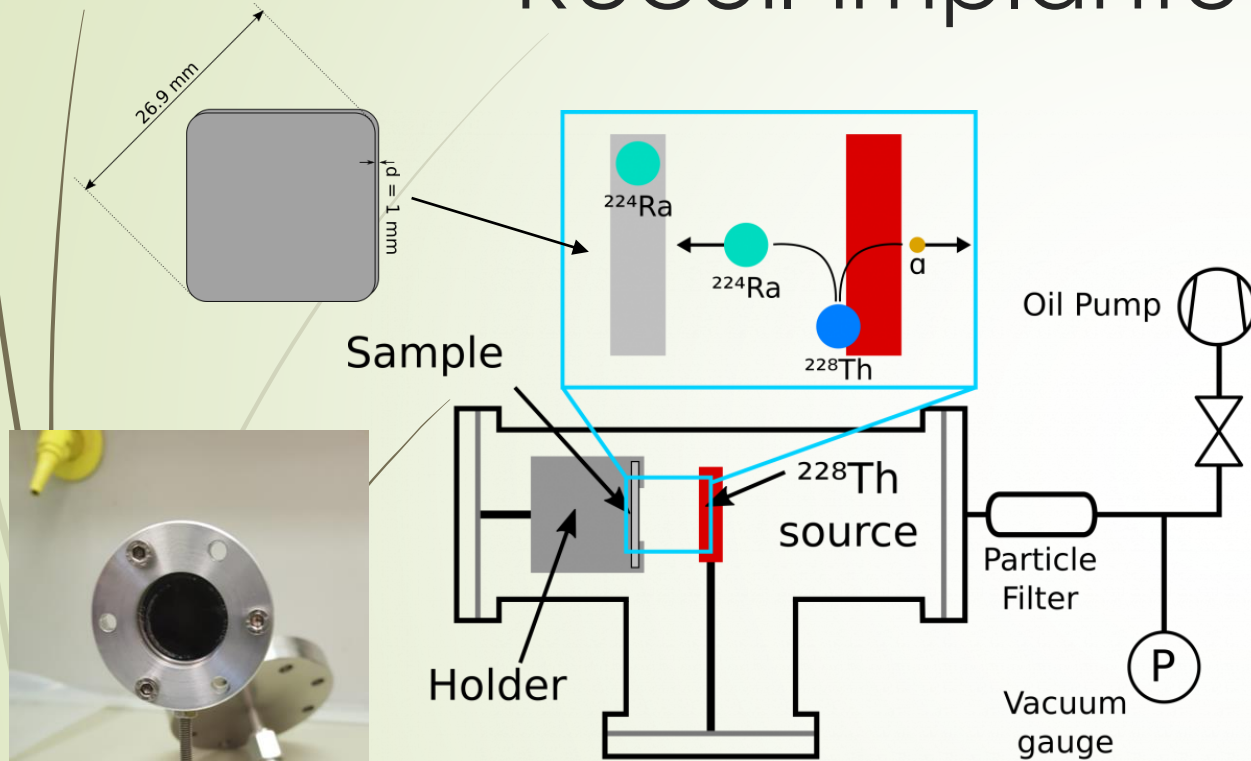


H. Simgen, MPIK, TAUP 2023

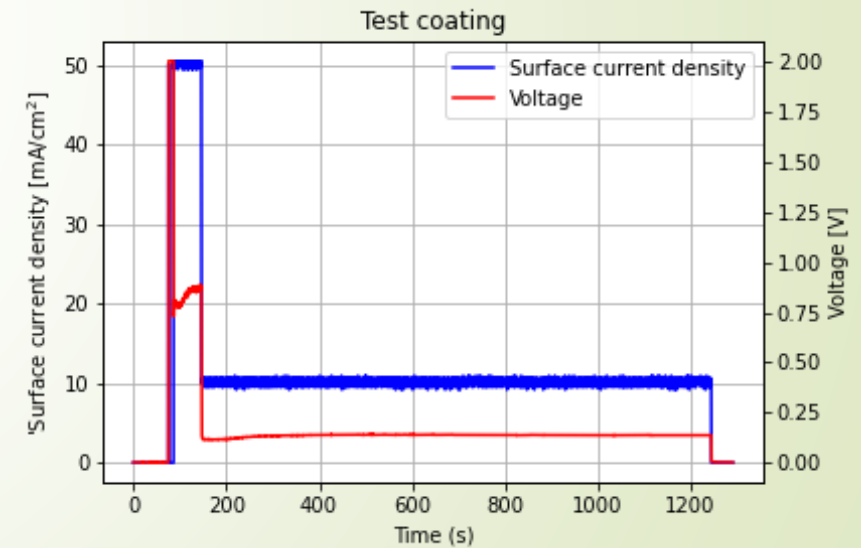
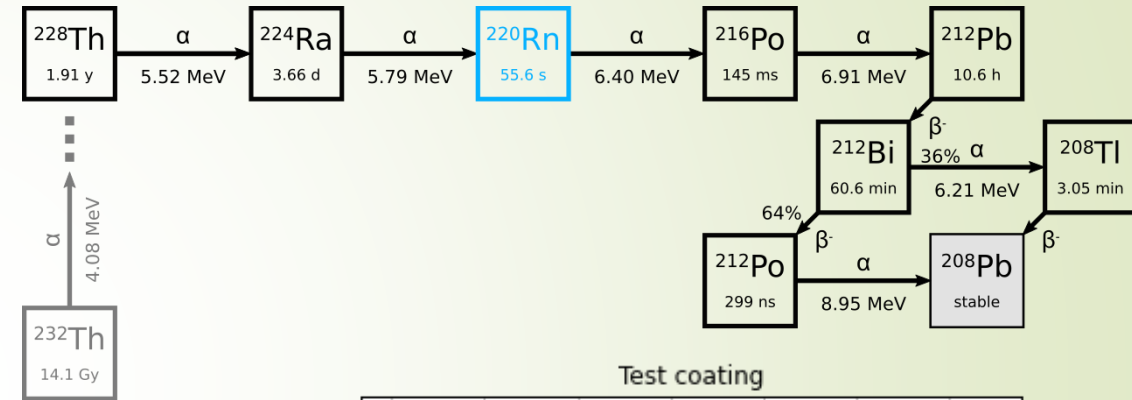


August, 28th 2023

From tungsten to stainless steel (SS): Recoil-implanted ^{224}Ra

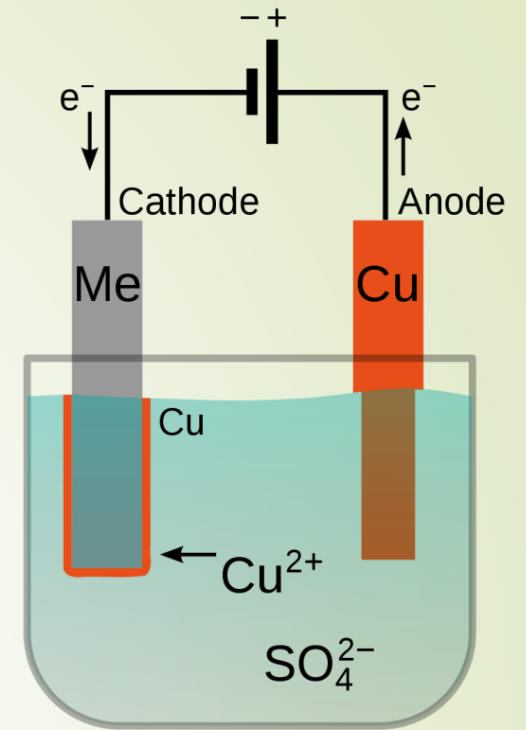
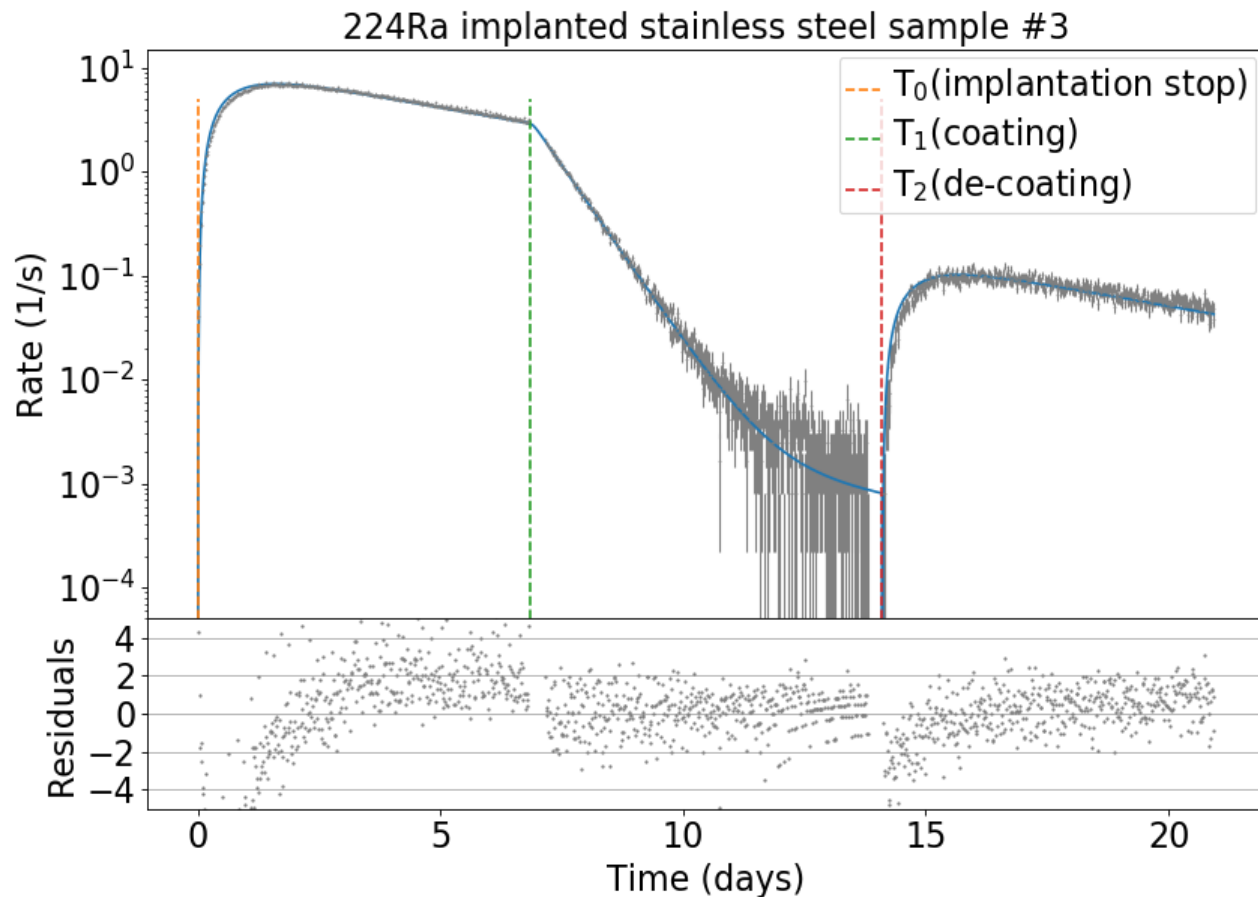


- ^{228}Th source recoils ^{224}Ra into SS disc.
- → Short-lived ($t_H=3.7$ days) ^{220}Rn -emanating SS sample.
- Easy to produce, relatively high activity.
- Re-consider plasma deposition with improved samples.



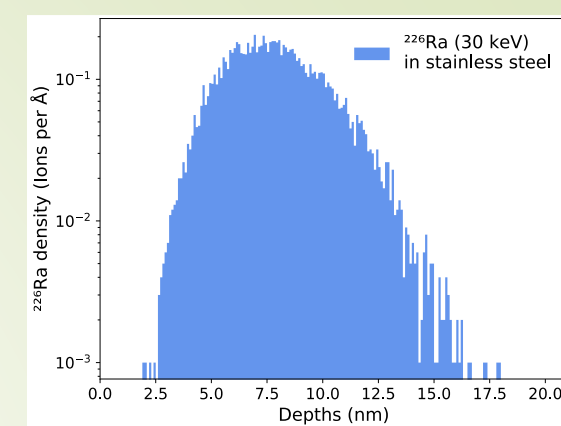
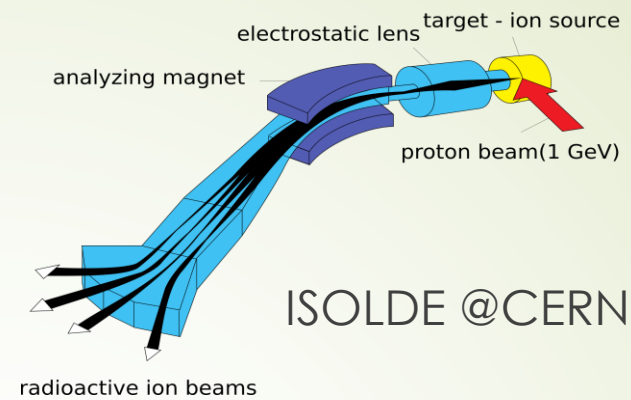
Procedure modification : Adhesion layer (~1 μm) for mechanical stability.

Coating (and de-coating) of ^{224}Ra -implanted SS disc



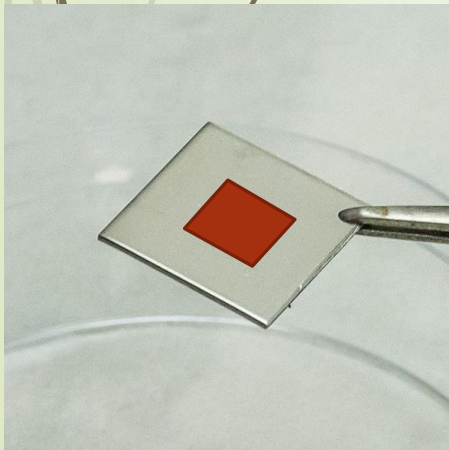
- ^{224}Ra decays on SS disc.
- ^{220}Rn is emanated and measured through ^{212}Po alpha-decays.
- Possible issue: Activity wash-off in electrolyte.
- Implantation \rightarrow coating \rightarrow de-coating
 - Upper limit from coating.
 - Lower limit from de-coating.
- Results for reduction factor R: **$20 < R < 1000$** .

^{222}Rn on stainless steel



- ^{226}Ra -implanted stainless steel discs (2cm x 2cm).
- Produced at ISOLDE facility (CERN).
- 30 keV implantation energy.
- 2 test samples produced in 2017.
- 20 new samples approved (not only stainless steel), production in 2023.

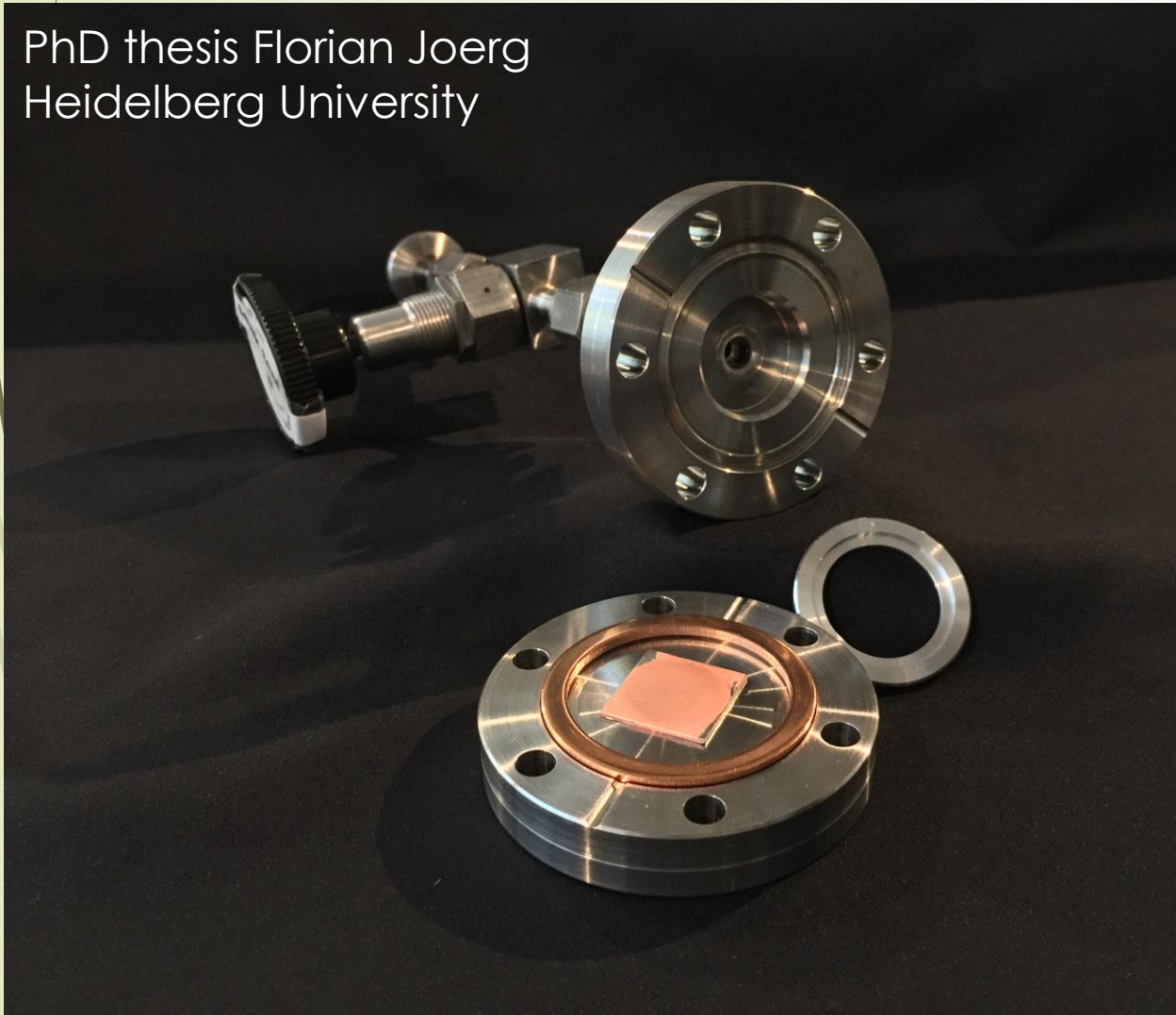
- Sample characterization published in *Appl. Rad. Isot.* 194 (2023) 110666.
- Alpha measurement:
 - ~ 8.5 Bq ^{226}Ra activity.
 - Central deposition confirmed.
- Gamma measurement confirms alpha measurement.
- Direct ^{222}Rn emanation test with proportional counters:
 - Sample a: (2.00 ± 0.05) Bq
 - Sample b: (2.07 ± 0.05) Bq
- Wipe test: Less than 1% of activity removed.



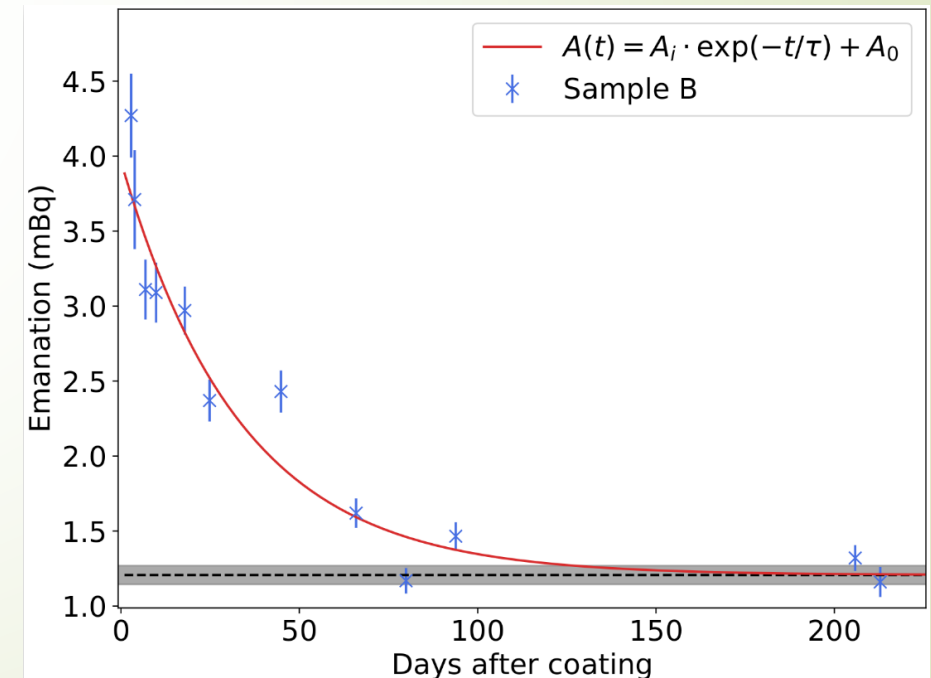
Measurement		Result (Bq)
^{222}Rn emanation	a	2.07 ± 0.03 (stat) ± 0.04 (syst)
	b	2.00 ± 0.03 (stat) ± 0.04 (syst)
γ -spectrometry	a	7.4 ± 0.1 (stat) ± 0.9 (syst)
	b	8.4 ± 0.3 (stat) ± 1.0 (syst)
α -spectrometry	a	8.7 ± 0.1 (stat) $^{+2.0}_{-1.8}$ (syst)
	b	9.1 ± 0.1 (stat) $^{+0.7}_{-0.4}$ (syst)

Coating of the 1st ISOLDE sample

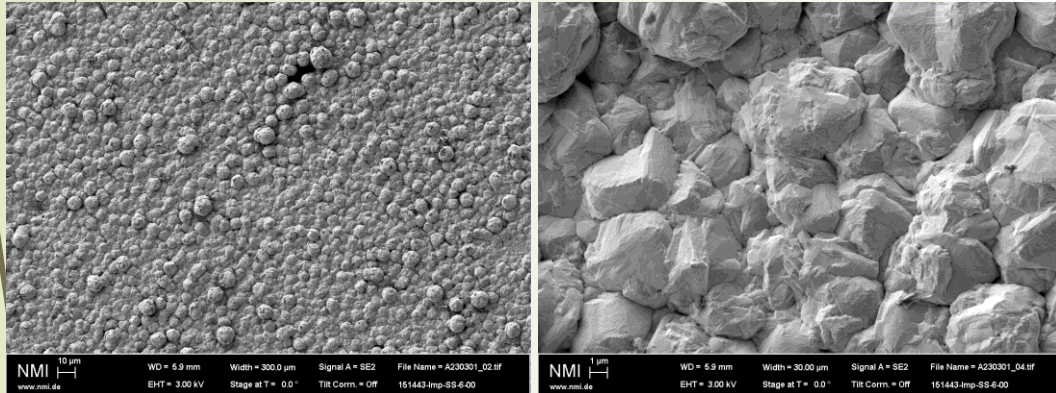
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Heidelberg University



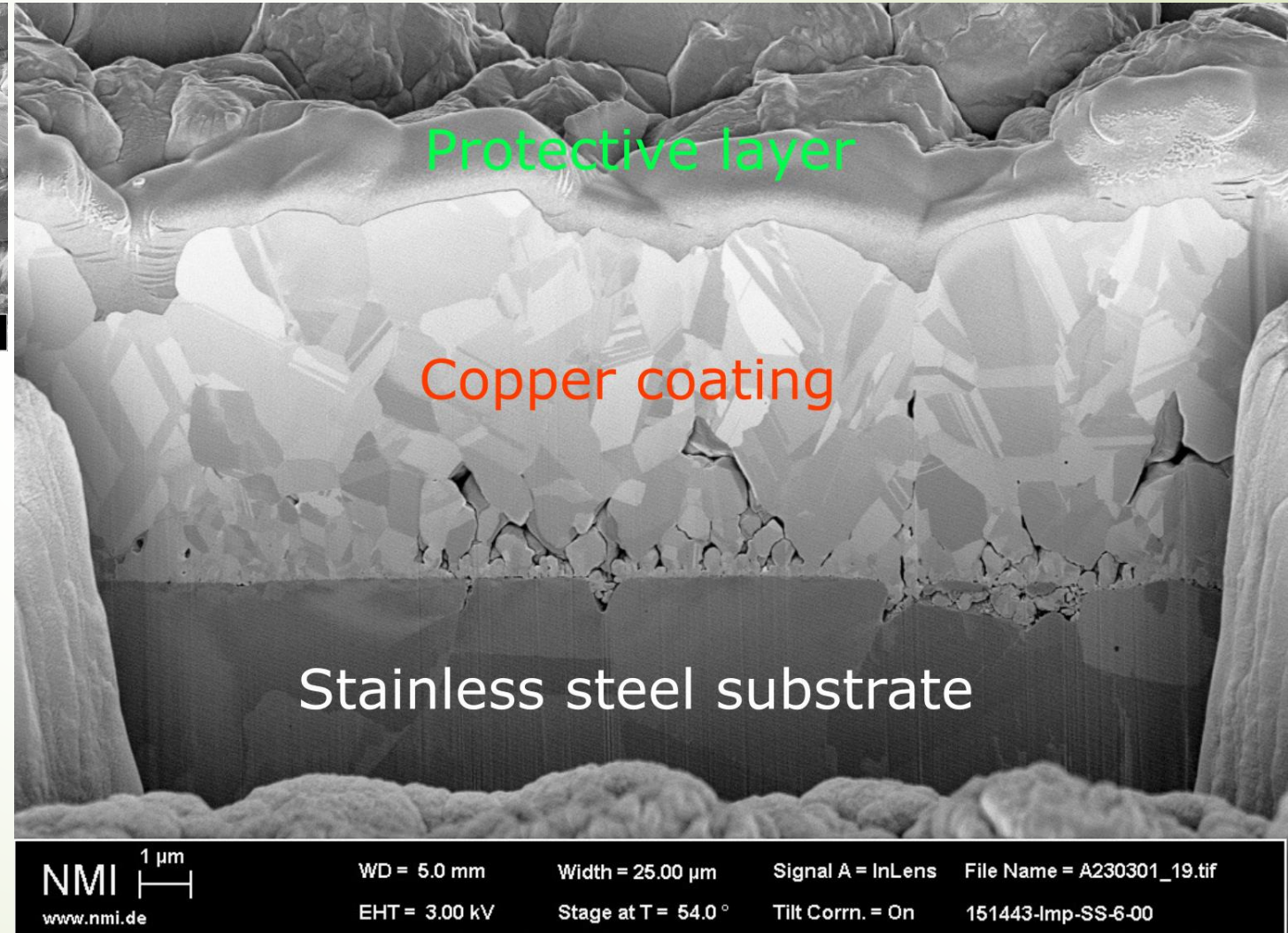
- Standard MPIK electro-chemical copper-on-steel coating recipe applied.
- Unexpected large ^{222}Rn reduction factor!
- Increased over time **from 450 to 1700**:
Copper layer re-arrangement?



Secondary Electron Microscopy (SEM) investigation of our coating



- Rough surface texture with spherical structures.
- Unhomogeneous adhesive layer with small grain size and holes.
- Tight cover layer with larger grains.



Summary and outlook



New electrode design
for coating of
cylindrical vessel

- Surface coating is a promising technology for radon mitigation.
- Electro-deposition of copper showed best reduction results.
- Future work focus on:
 - Coating characterization (SEM, X-ray, ...)
 - Purity of coating:
 - Cleanliness of electrolyte (Deposition of impurities).
 - Up-scaling:
 - Development of new setup to coat ~15 liter vessel.
 - New ISOLDE samples will allow for more systematic studies.

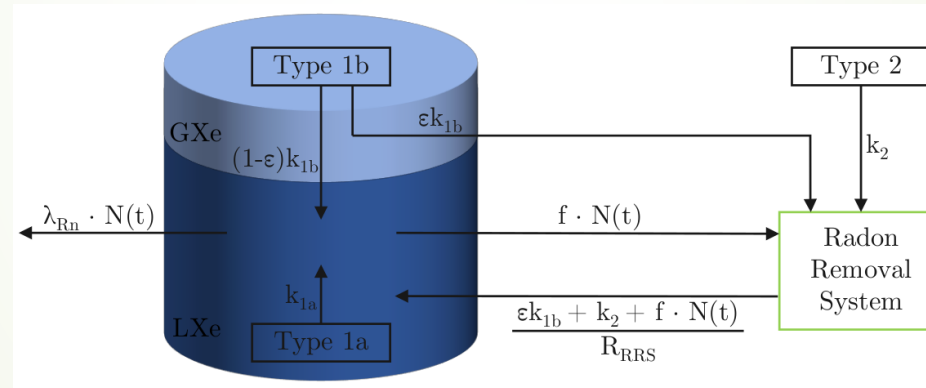
Backup

Radon removal by xenon distillation

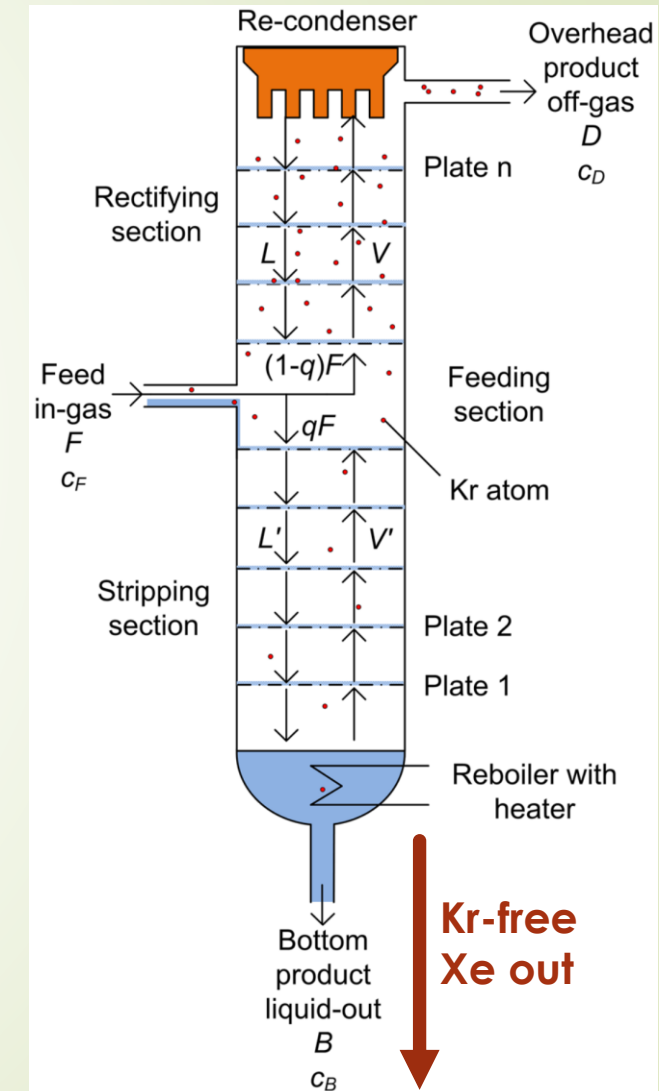
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- Radon is less volatile than xenon → reverse operation mode w.r.t. Kr removal.
- Feasibility demonstrated in Xenon100: [EPJC \(2017\) 77:358](#)
- Applied in XENON1T: 4.5 μBq/kg achieved: [EPJC \(2021\)81:337](#)
- High flow radon removal system developed for XENONnT: [arXiv: 2205.11492](#)

➤ **1.7 μBq/kg achieved**



- Upscaling only possible for high throughput system.
- Processing speed for DARWIN must be ≥ 10 tons/day.
- Efficiency in power consumption and xenon holdup versus radon reduction is crucial.

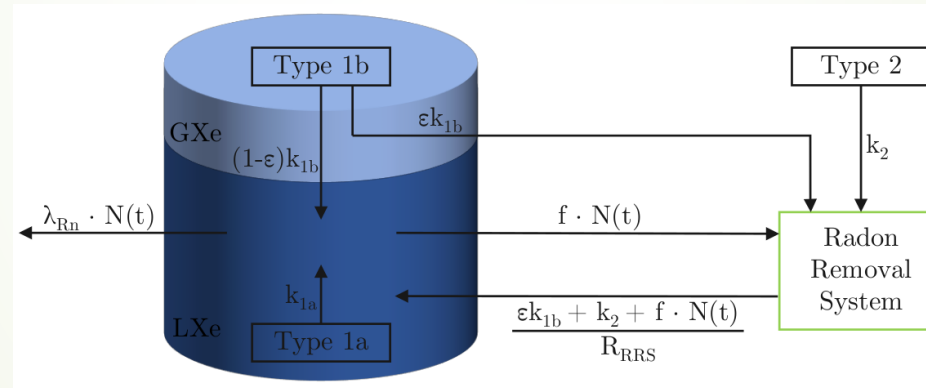


Radon removal by xenon distillation

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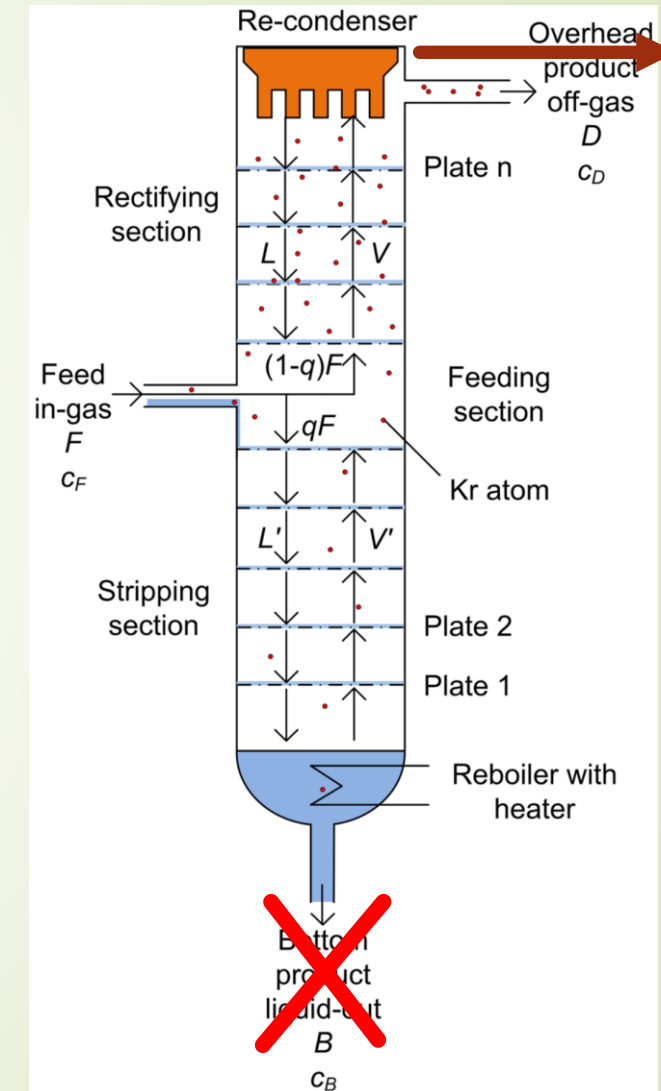
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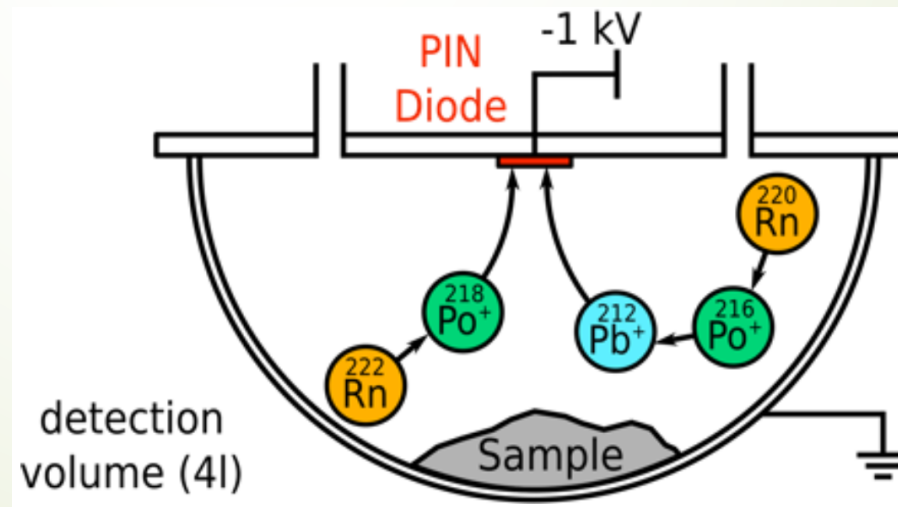
Rn-free
Xe out



^{222}Rn emanation measurements at MPIK



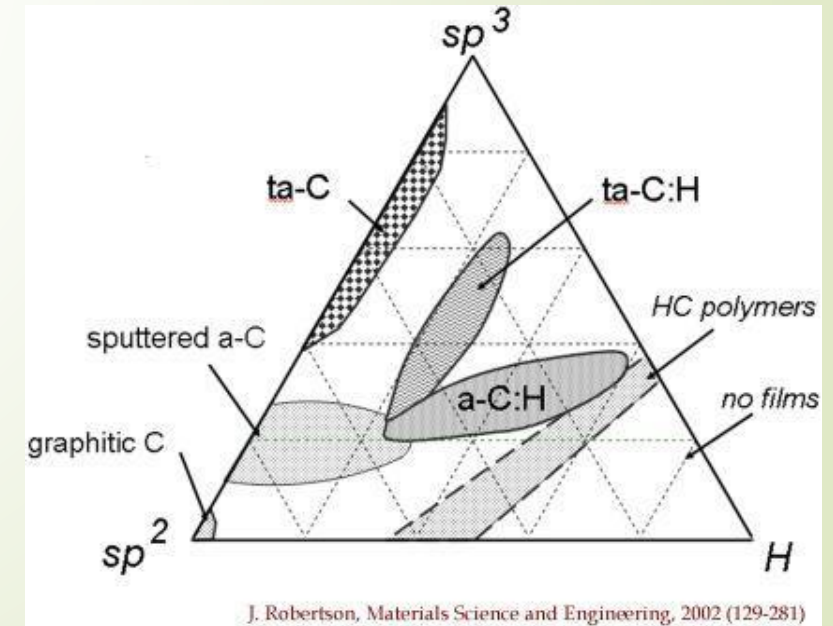
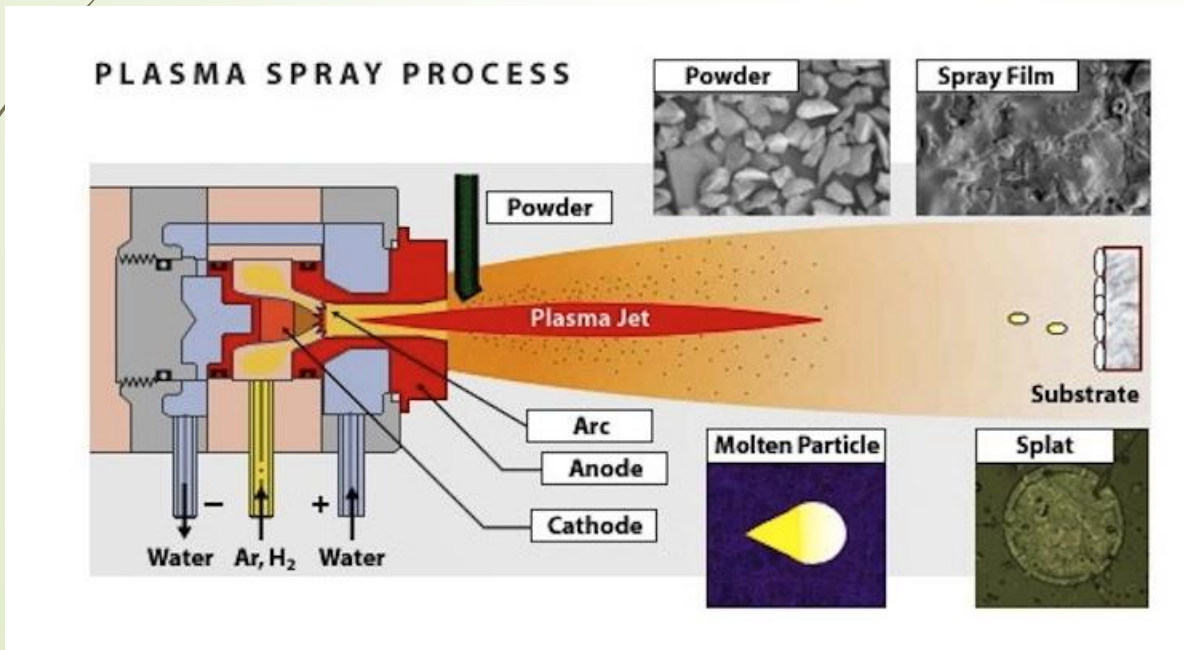
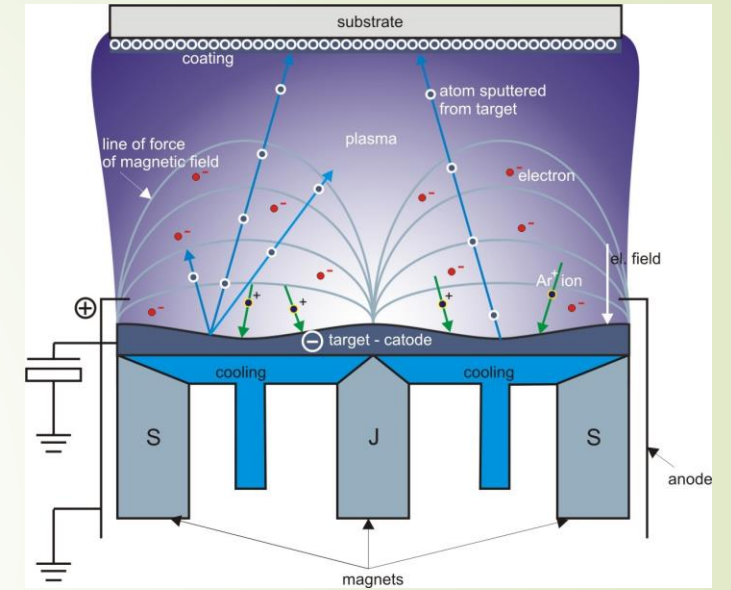
- MPIK ^{222}Rn infrastructure:
 - >20 ultralow background miniaturized proportional counters
 - Sensitivity: ~ 10 atoms.
 - 8 parallel counting lines.
 - Fully automated ^{222}Rn concentration system (AutoEma).
 - ~ 15 sample vessels (0.1 – 80 lit.).
 - 3 electro-static ^{222}Rn monitors.



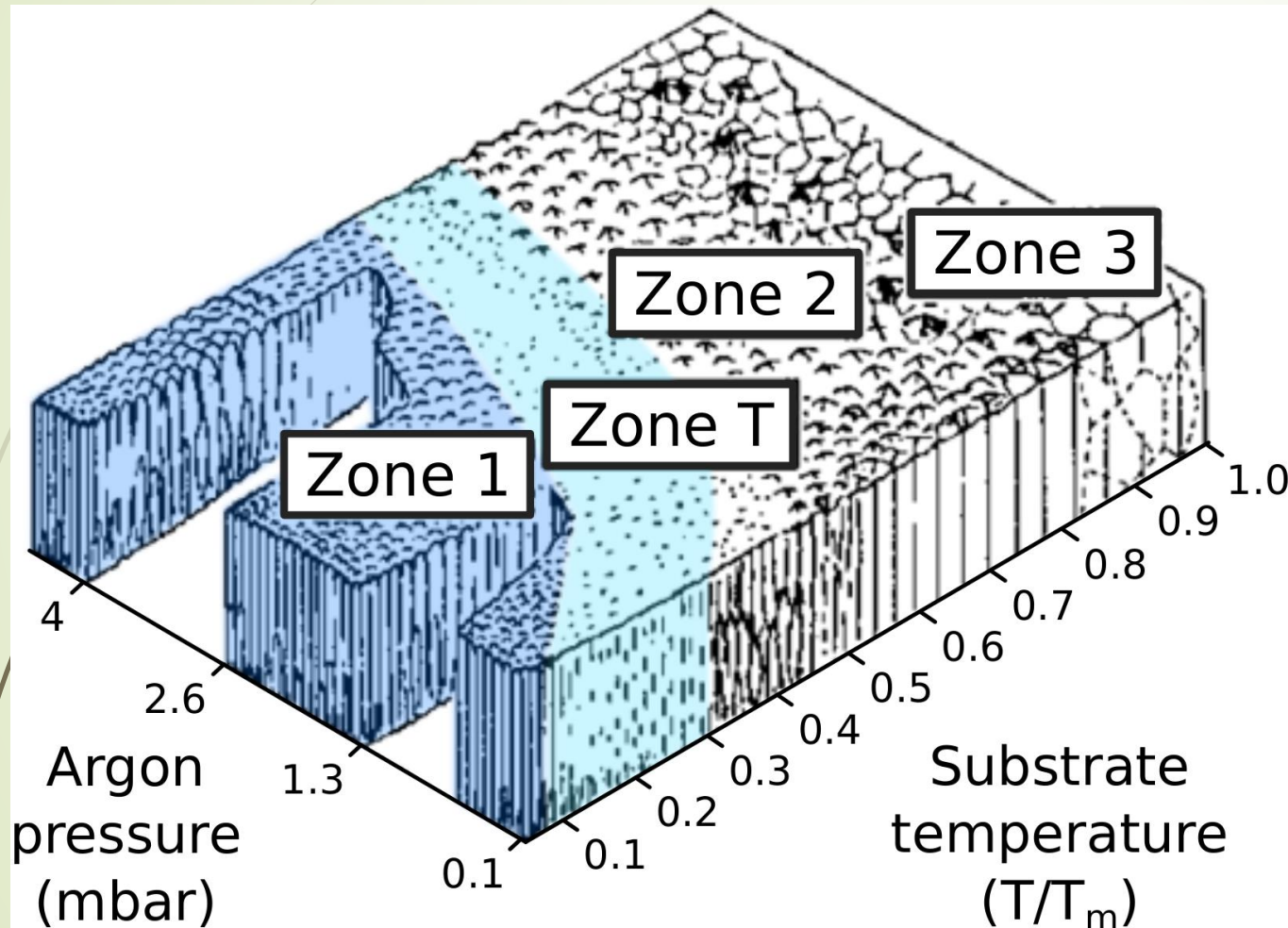
Investigated vacuum coating techniques

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- ▶ Physical vapor deposition (PVD).
 - ▶ Titanium sputtering.
- ▶ Chemical vapor deposition (CVD).
 - ▶ Amorphous hydrogenated carbon coating (a-C:H).
- ▶ Copper plasma deposition.



Thornton structure zone model:



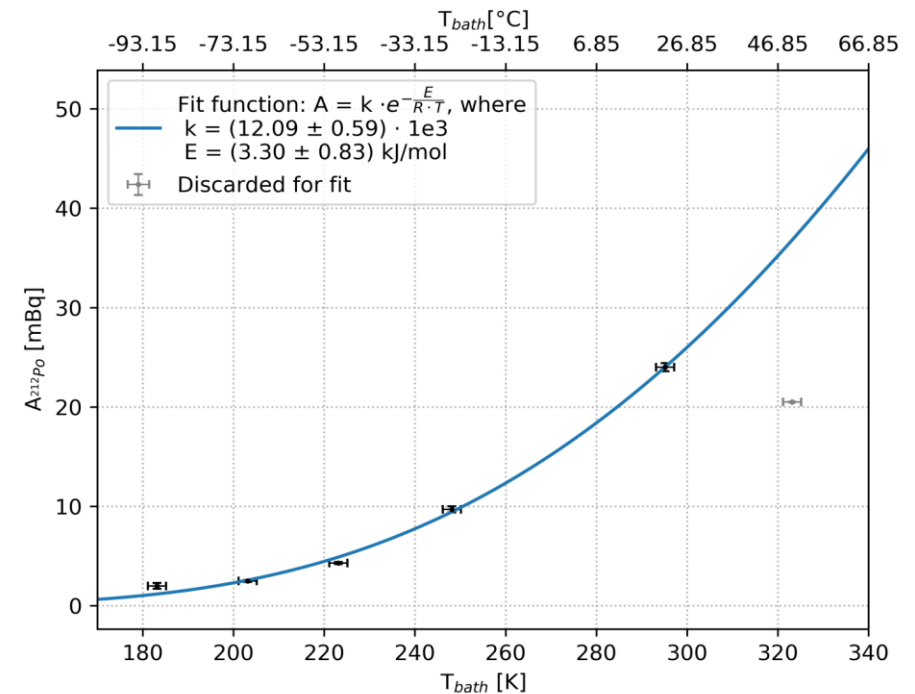
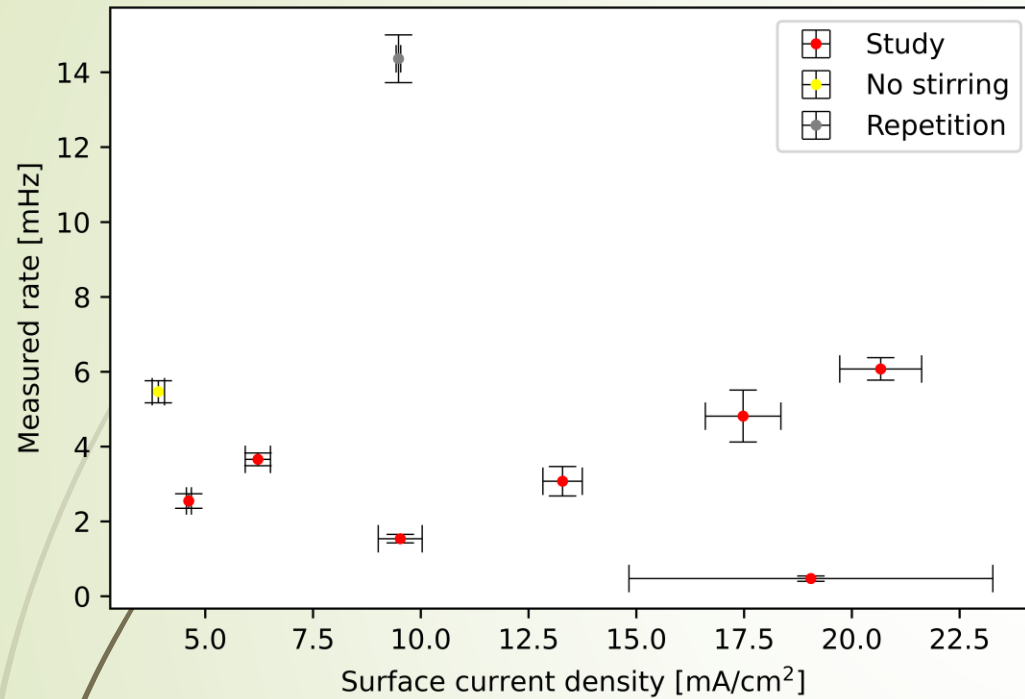
- ▶ Sputtering is low temperature process.
- ▶ Growth of vertically aligned grain boundaries.
- ▶ May block reactive gases (corrosion protection), but „diffusion highway“ for noble gases.
- ▶ Focus on high temperature applications (plasma coating) or non vacuum-growth technique.
- ▶ But what about CVD?

Summary of results from 1st phase

Method	Coated material	Company	²²⁰ Rn reduction	²²² Rn reduction
Sputtering	Ti	Europcoating	1 – 5	~1
Plasma deposition	Cu	Dr. Laure	2 – 20	---
Chemical vapor deposition	C	Innovative Coating Solutions	~3	~1,5
Electro chemical	Cu on W	MPIK	O(100)	1 – 8
Electro chemical	Cu on SS	MPIK	20 – 1000	---

- Focus on electro-chemical plating (but don't forget plasma deposition).

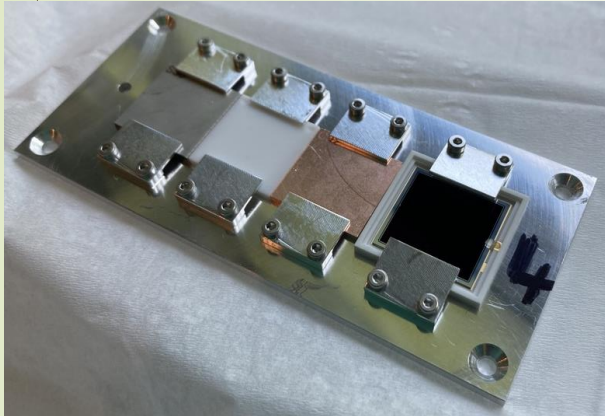
Optimization of Cu coating procedure and ^{220}Rn reduction results



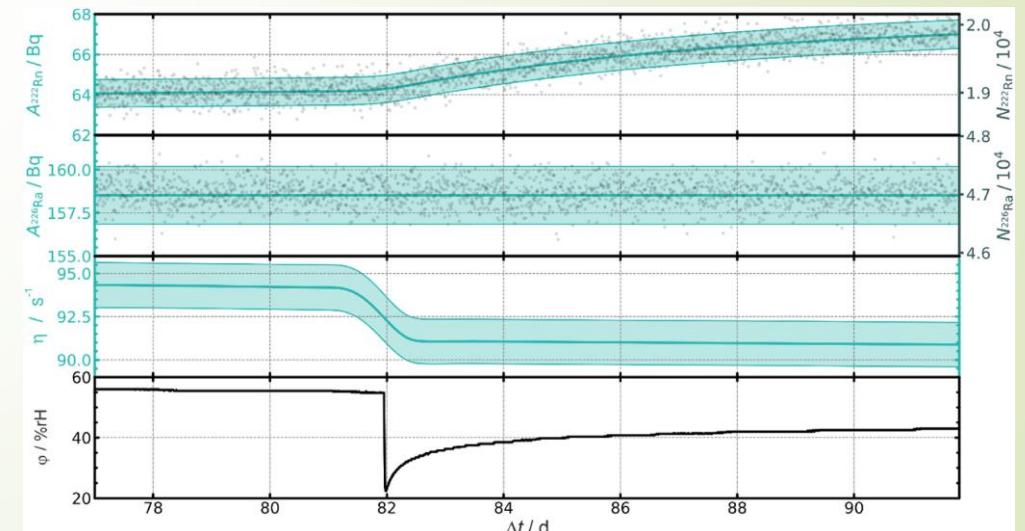
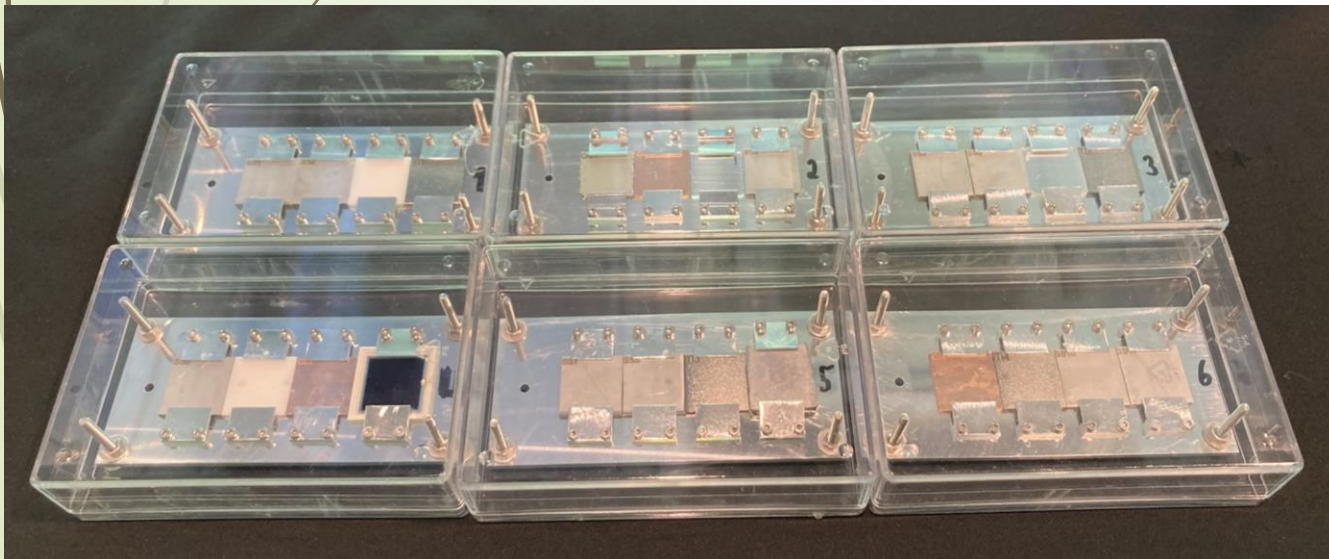
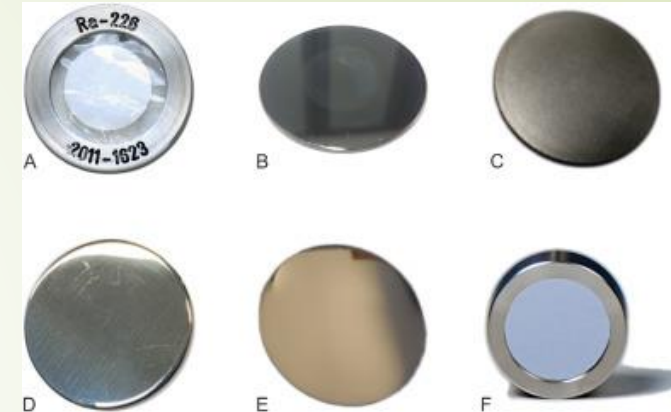
- Optimum surface current density identified.
- Avoid whisker growing by careful parameter control.
- Diffusion-driven emanation confirmed by tests at different temperatures.
- Even hints for slight ^{222}Rn reduction.

Novel ^{222}Rn sources

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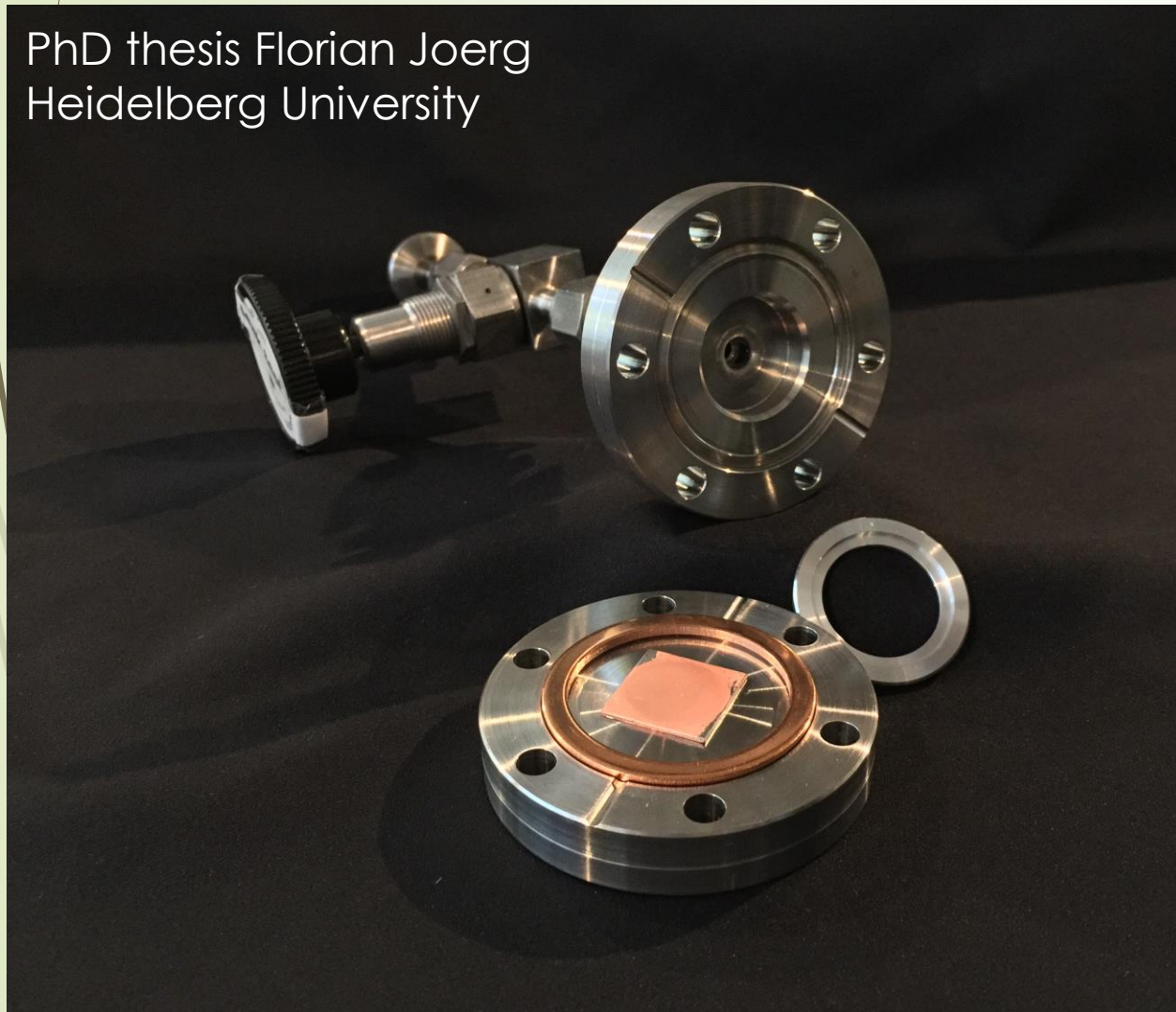
- ^{226}Ra implantation in SS, Cu, Ti, Pb, Ge, Si, PTFE, SiO_2 , acrylic.
- 20 – 24 new samples.
- Similar development at PTB (Braunschweig) → Traceable ^{222}Rn sources.
- Deposition on an active Si detector allows online emanation rate monitoring.



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Coating of the 1st ISOLDE sample

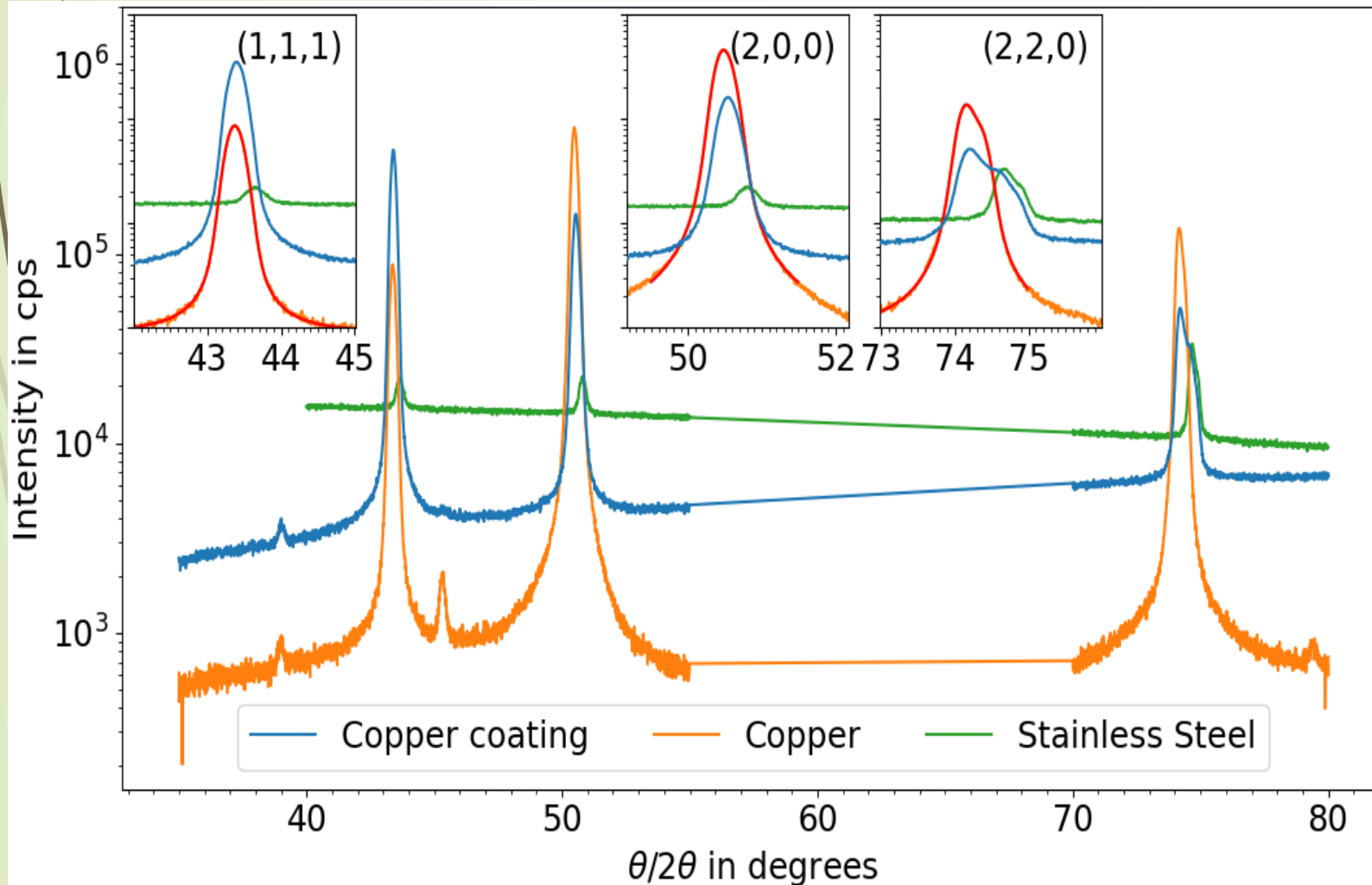
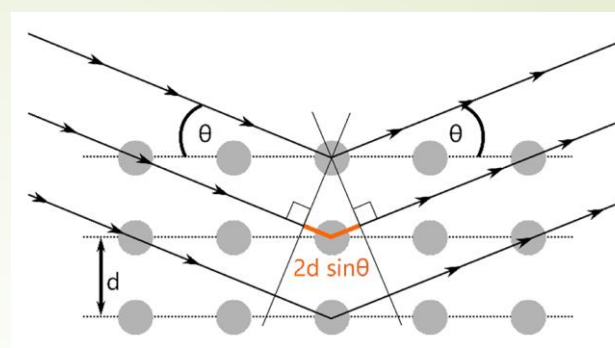
PhD thesis Florian Joerg
Heidelberg University



- Standard MPIK electrochemical Cu-on-SS coating recipe applied.
- ^{222}Rn emanation rate
 - Before coating: (2.00 ± 0.05) Bq.
 - After coating: (4.3 ± 0.3) mBq.
- Unexpected large ^{222}Rn reduction factor: ~ 465 .
- Gamma spectroscopy results:

Activity [Bq]	^{226}Ra (186 keV)	^{222}Rn daughters
ISOLDE sample before coating	8.4 ± 1.0	6.0 ± 0.3
ISOLDE sample after coating	7.7 ± 1.0	7.2 ± 0.4
Electrolyte after coating	---	0.34 ± 0.02

X-ray diffraction



- Very preliminary study.
- Done at Heidelberg University (IMSEAM: Institute for molecular systems engineering and advanced materials).
- Basic features as expected, but some unexplained effects:
 - Amplitude ratios doesn't always match expectation (directionality in lattice?).
 - Peak positions slightly shifted (material stress?).
 - Not understood low intensity peaks.